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January 2011

FSAV430 Low Voltage 1.1GHz, 4-Channel, 2:1 Video Switch

Features

- -40dB Off Isolation at 30MHz
- -60dB Non-Adjacent Channel Crosstalk at 30MHz
- 3dB Bandwidth: 1.1GHz
- On Resistance: 4.5Ω (Typical)
- Low Power Consumption: 1µA (Maximum)
- Control Input TTL Compatible
- Bidirectional Operation

Applications

- RGB Video Switch in LCD, Plasma and Projector Displays
- DVD-RW

Description

The FSAV430 is a high performance Quad Single-Pole. Double Throw (SPDT) (2-to-1 multiplexer demultiplexer) video switch designed specifically for switching high definition YPbPr and computer RGB (up to UXGA) signals. The bandwidth of this device is 1.1GHz (typical) which allows signals to pass with minimal edge and phase distortion. Image integrity is maintained with low crosstalk, high off-isolation and low differential gain and phase. The low on resistance (4.5 Ω typical) minimizes signal insertion loss. Low voltage operation (3V), low power consumption (1µA maximum) and small scale packaging make this device ideal for a broad range of applications.

Ordering Information

Part Number	Operating Temperature Range	Package	Packing Method
FSAV430MTCX	-40 to +85°C	16-Lead, Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide	Tape and Reel
FSAV430QSCX	-40 to +85°C	16-Lead, Quarter Size Outline Package (QSOP), JEDEC MO-137, 0.150 inch Wide	Tape and Reel

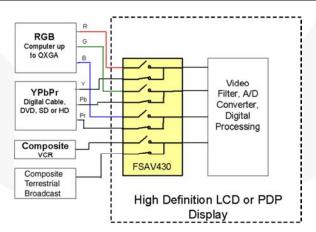
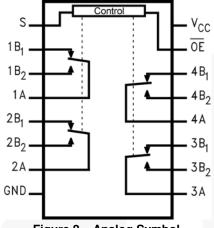


Figure 1. Typical Application Diagram

Pin Configurations





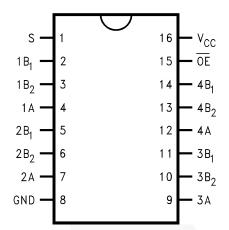


Figure 3. QSOP and TSSOP Pin Assignments

Pin Descriptions

Pin #	Name	Description
15	/OE	Bus Switch Enabled
1	S	Select Input
4, 7, 9, 12	A	Bus A
2, 3, 5, 6, 10, 11,13, 14	B ₁ -B ₂	Bus B
8	GND	Ground
16	V _{cc}	Supply Voltage

Truth Table

S	/OE	Function
Don't Care	HIGH	Disconnected
LOW	LOW	A=B ₁
HIGH	LOW	A=B ₂

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Min.	Max.	Unit
V _{CC}	Supply Voltage	-0.5	+4.6	V
Vs	DC Switch Voltage	-0.5	V _{CC} +0.5	V
V _{IN}	DC Input Voltage ⁽¹⁾	-0.5	+4.6	V
I _{IK}	DC Input Diode Current, V _{IN} < 0V	-50		mA
I _{OUT}	DC Output Sink Current		128	mA
I _{CC} /I _{GND}	DC V _{CC} / GND Current		±100	mA
T _{STG}	Storage Temperature Range	-65	+150	°C
ESD	Human Body Model, JESD22-A114		4000	V

Note

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

Symbol	Parar	Min.	Max.	Unit	
V _{CC}	Power Supply		3.0	3.6	V
V _{IN}	Input Voltage	Input Voltage		V_{CC}	V
V _{OUT}	Output Voltage		0	V_{CC}	V
	Input Rise and Fall Time	Switch Control Input	0	5	ns/V
t _r , t _f	Switch I/O		0	DC	TIS/ V
T _A	Operating Temperature, Free Air		-40	+85	°C

Note:

2. Unused control inputs must be held HIGH or LOW; they may not float.

^{1.} The input and output negative voltage ratings may be exceeded if the input and output diode current ratings are observed.

DC Electrical Characteristics

Typical values are at T_A = +25°C.

Cymphal	Dovomotov	Canditions	V (V)	T _A = -40 to +85°C			
Symbol	Parameter	Conditions	V _{cc} (V)	Min.	Тур.	Max.	Units
V _{ANALOG}	Analog Signal Range			0		2	V
V _{IK}	Clamp Diode Voltage	I _{IN} =-18mA	3.0			-1.2	V
V _{IH}	High-Level Input Voltage		3.0 to 3.6	2.0			V
V _{IL}	Low-Level Input Voltage		3.0 to 3.6			0.8	V
I _I	Input Leakage Current	$0 \leq V_{IN} \leq 3.6V$	3.6			±1.0	μΑ
I _{OFF}	Off-State Leakage Current	$0 \le A, B \le V_{CC}$	3.6			±1.0	μΑ
В	R _{ON} Switch On Resistance ⁽³⁾	$V_{IN}=1.0V, R_{I}=75\Omega, I_{ON}=13mA$	3.0		5.0	7.0	
R _{ON}	Switch On Resistance	$V_{IN}=2.0V, R_{I}=75\Omega, I_{ON}=26mA$	3.0		4.5	6.0	Ω
R _{FLAT(ON)}	On Resistance Flatness ⁽⁴⁾	I _{OUT} =13mA, V _{IN} =0 to V _{CC}	3.0		1		
Icc	Quiescent Supply Current	V _{IN} =V _{CC} or GND, I _{OUT} =0	3.6			1	μΑ
Δl _{CC}	Increase in I _{CC} per Input	One Input at 3.0V Other Inputs at V _{CC} or GND	3.6			30	mA

Notes:

- Measured by the voltage drop between the A and B pins at the indicated current through the switch. On resistance is determined by the lower of the voltages on the A or B pins.
- 4. Flatness is defined as the difference between the maximum and minimum value on resistance over the specified range of conditions.

AC Electrical Characteristics

Typical values are at V_{CC} =3.3V and T_A = +25°C.

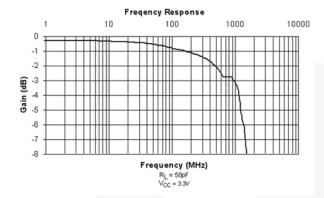
Symbol Parameter		Conditions	V	T _A =	-40 to+8	35°C	Units	Eiguro
Symbol	Parameter	Conditions	V _{cc}	Min.	Тур.	Max.	Units	Figure
	Turn On Time S to Bus A	B _n =2V	3 C to 3 G		4.8	7.0	no	Figure 11,
t _{ON}	Output Enable Time OE to A		3.0 to 3.6		4.5	6.8	ns Figure 12	
	Turn Off Time S to Bus A	B _n =2V			2.2	4.0		Figure 11,
t _{OFF}	Output Disable Time OE to A		3.0 to 3.6		2.2	3.5	ns	Figure 12
D _G	Differential Gain	R _L =75Ω, f=3.58MHz	3.0 to 3.6		0.2		%	Figure 5, Figure 6
D _P	Differential Phase	$R_L=75\Omega$, f=3.58MHz	3.0 to 3.6		0.1		٥	Figure 5, Figure 6
O _{IRR}	Non-Adjacent Off Isolation	R _L =75Ω, f=30MHz	3.0 to 3.6		-40		dB	Figure 7, Figure 13
X _{TALK}	Non-Adjacent Channel Crosstalk	$R_L=75\Omega$, f=30MHz	3.0 to 3.6		-60		dB	Figure 8, Figure 14
D	B _w -3dB Bandwidth —	$R_L=50\Omega$	3.0 to 3.6		800			Figure 4,
ΒW		$R_L=75\Omega$			600			Figure 15

Capacitance

Typical values are at V_{CC} = 3.3V and T_A =+25°C.

Symbol	Parameter	Conditions	Тур.	Units
C _{IN}	Control Pin Input Capacitance	V _{CC} =0V	2.5	pF
C _{ON}	A/B On Capacitance	V _{CC} =3.3V, /OE=0V	12.0	pF
C_{OFF}	Port B Off Capacitance	V _{CC} =/OE=3.3V	4.0	pF

AC Characteristics



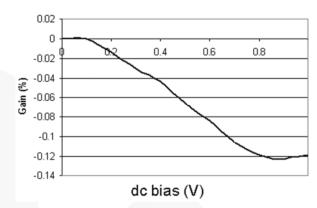


Figure 4. Gain vs. Frequency

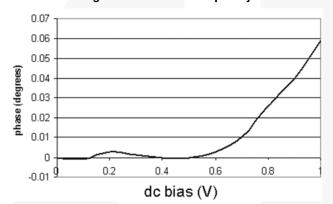
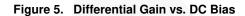


Figure 6. Differential Phase vs. DC Bias



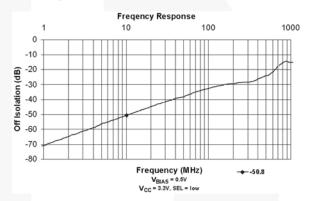


Figure 7. Off Isolation

AC Characteristics

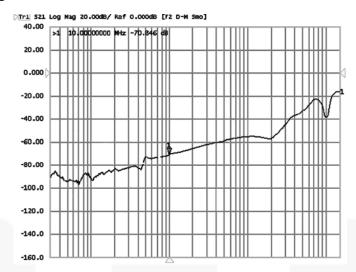


Figure 8. Off Crosstalk vs. Frequency

RON Switch Characteristics

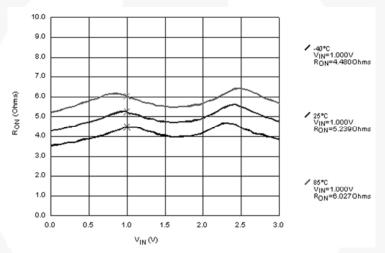


Figure 9. R_{ON} Switch On Resistance, I_{ON}=13mA, V_{CC}=3.0V

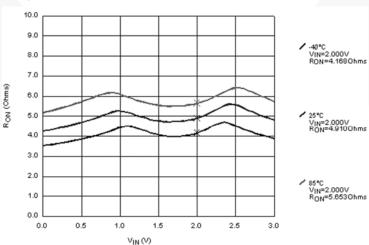
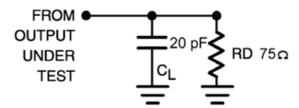


Figure 10. R_{ON} Switch On Resistance, I_{ON}=26mA, V_{CC}=3.0V

AC Loadings and Waveforms



Notes:

- 5. Input drive by 50Ω source terminated in 50Ω .
- 6. C includes load and stray capacitance.
- 7. Input PRR=1.0MHz, t_W=500ns.

Figure 11. AC Test Circuit

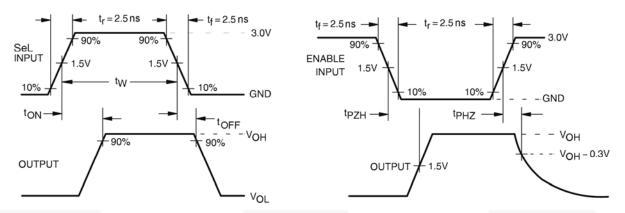
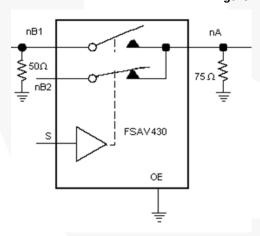


Figure 12. AC Waveforms



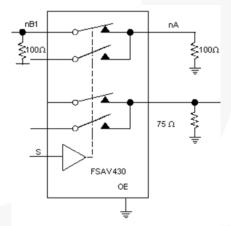


Figure 13. Off Isolation Test

Figure 14. Crosstalk

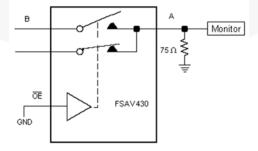
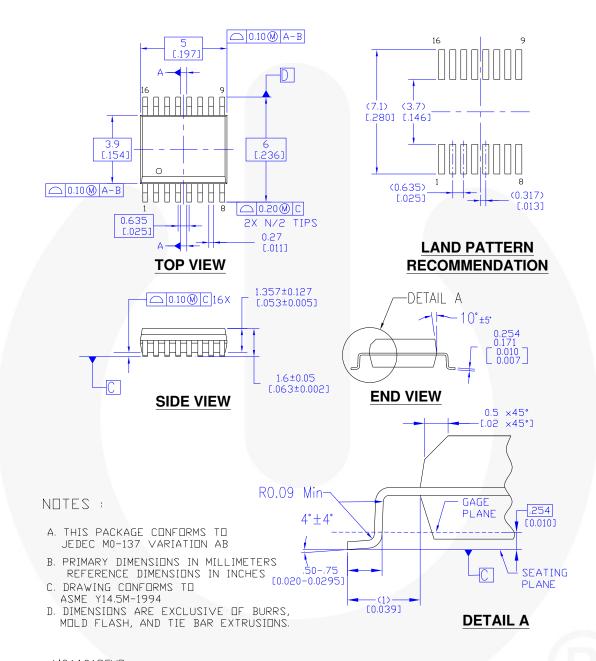


Figure 15. Bandwidth

Physical Dimensions



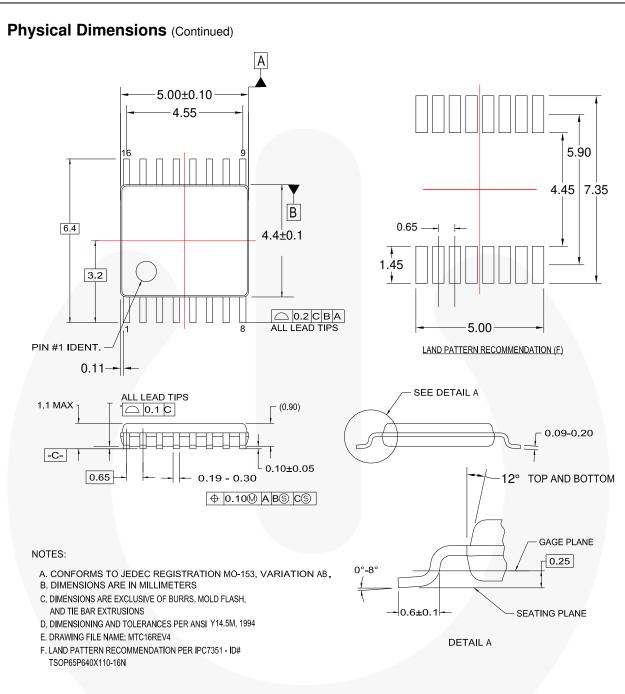
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Figure 16. 16-Lead, Quarter Size Outline Package (QSOP)

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MTC16rev4

Figure 17. 16-Lead, Thin Shrink Small Outline Package (TSSOP)

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